

10 9 8 7 6 5 4 3 2 1

F

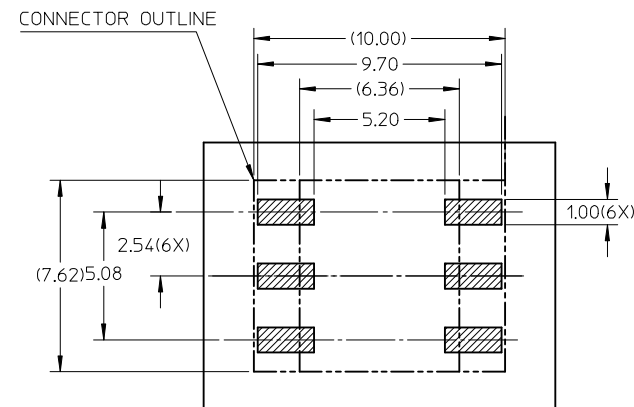
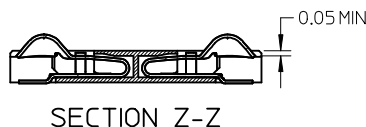
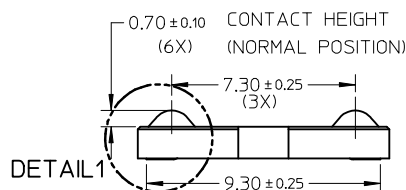
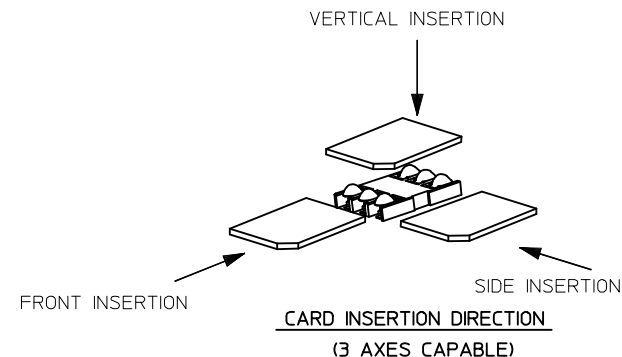
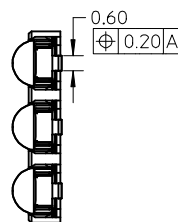
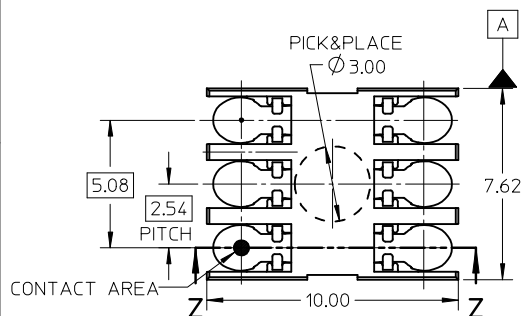
E

D

C

B

A



RECOMMENDED PCB LAYOUT
(TOLERANCE ±0.05)

NOTES:

1.MATERIAL

HOUSING:LCP 30% GLASS FILLED,UL94 V-0,BLACK
TERMINAL:PHOSPHOR BRONZE 0.12MM THICKNESS

2.PLATING

CONTACT AREA--0.5 MICROMETER MIN GOLD
SOLDER TAIL--GOLD FLASH
UNDERPLATING--2 MICROMETER NICKEL OVERALL

3.PRODUCT COMPLIANT TO ROHS DIRECTIVE 2002/95/EC
AND ELV DIRECTIVE 2000/53/EC

NEW RELEASE	2008/10/16	DRWN:YPMU CHKD:YLZHU02 APPR:	DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE MM ONLY		SCALE 5:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION					
					mm INCH		DRAWN BY LHSHEN	DATE 2006/10/10	1.3 HEIGHT BLOCK SIM CONNECTOR SALES DRAWING								
					3 PLACES ± --- ± ---		CHECKED BY XUXIANG	DATE 2006/10/15									
					2 PLACES ± 0.10 ± ---		APPROVED BY JENNY	DATE 2006/10/15									
					1 PLACE ± 0.20 ± ---		MATERIAL NO. 473121001		DOCUMENT NO. SD-47312-101		SHEET NO. 1 OF 1						
					ANGULAR ± 2°		MOLEX MOLEX INCORPORATED										
					DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS												
					A	REV						SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				